

# AlGaAs/GaAs T-1 3/4 PACKAGE

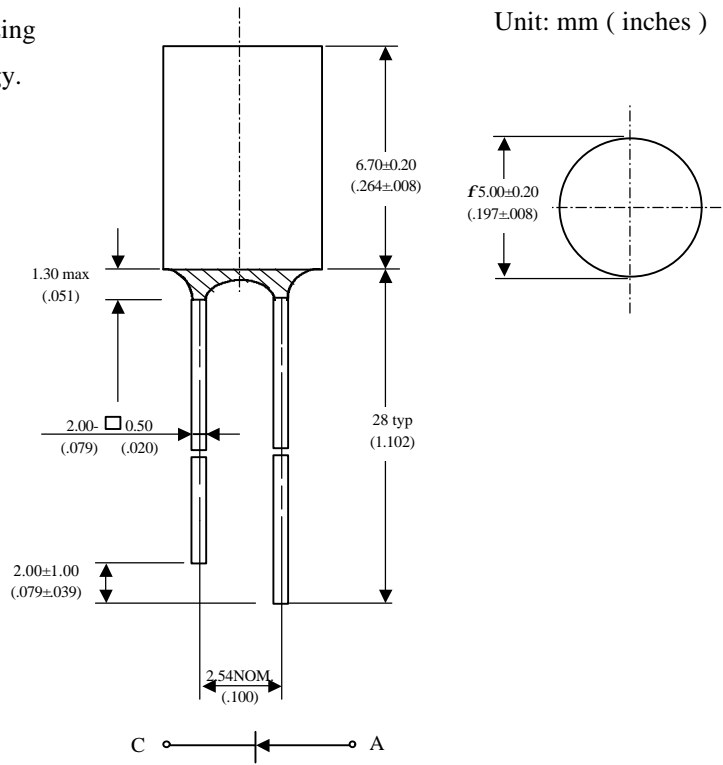
## INFRARED EMITTING DIODE

**MIE-814A2**

### Description

The MIE-814A2 is an infrared emitting diode utilizing GaAs with AlGaAs window coating chip technology. It is molded in water clear plastic package.

### Package Dimensions



### Features

- High radiant power and high radiant intensity
- Suitable for DC and high pulse current operation
- Peak wavelength  $\lambda_p = 940$  nm
- Good spectral matching to Si-Photodetector

#### NOTES :

1. Tolerance is  $\pm 0.25$  mm (.010") unless otherwise noted.
2. Protruded resin under flange is 1.5 mm (.059") max.
3. Lead spacing is measured where the leads emerge from the package.

### Absolute Maximum Ratings

@  $T_A = 25^\circ\text{C}$

Parameter	Maximum Rating	Unit
Power Dissipation	150	mW
Peak Forward Current	1	A
Continuous Forward Current	100	mA
Reverse Voltage	5	V
Operating Temperature Range	-55°C to +100°C	
Storage Temperature Range	-55°C to +100°C	
Lead Soldering Temperature	260°C for 5 seconds	



Unity Opto Technology Co., Ltd.

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## Optical-Electrical Characteristics

@ T<sub>A</sub>=25°C

Parameter	Test Conditions	Symbol	Min.	Typ .	Max.	Unit
Radiant Intensity	I <sub>F</sub> =20mA	I <sub>e</sub>	1	2		mW/sr
Forward Voltage	I <sub>F</sub> =50mA	V <sub>F</sub>		1.32	1.45	V
Reverse Current	V <sub>R</sub> =5V	I <sub>R</sub>			100	μA
Peak Wavelength	I <sub>F</sub> =20mA	λ		940		nm
Spectral Bandwidth	I <sub>F</sub> =20mA	Δλ		50		nm
View Angle	I <sub>F</sub> =20mA	2 θ <sub>1/2</sub>		50		deg .

## Typical Optical-Electrical Characteristic Curves

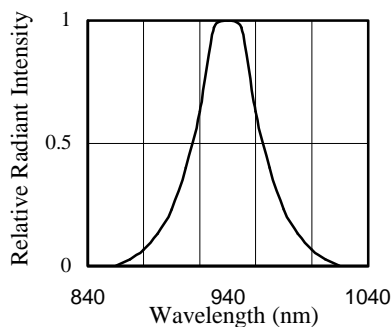


FIG.1 SPECTRAL DISTRIBUTION

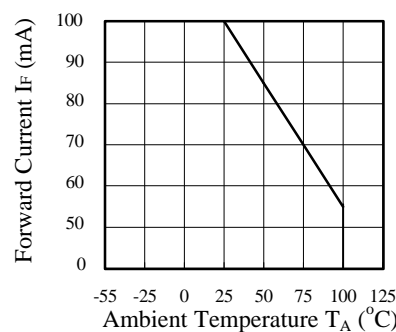


FIG.2 FORWARD CURRENT VS. AMBIENT TEMPERATURE

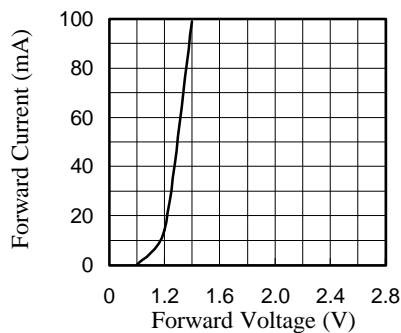


FIG.3 FORWARD CURRENT VS. FORWARD VOLTAGE

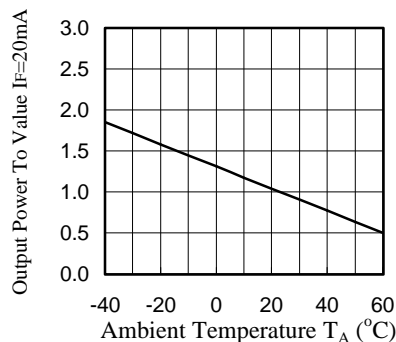


FIG.4 RELATIVE RADIANT INTENSITY VS. AMBIENT TEMPERATURE

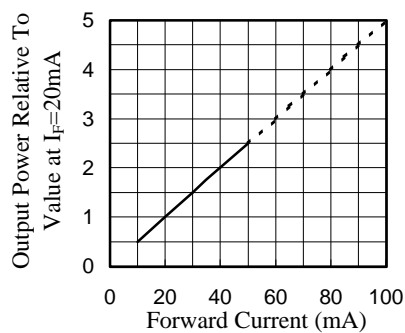


FIG.5 RELATIVE RADIANT INTENSITY VS. FORWARD CURRENT

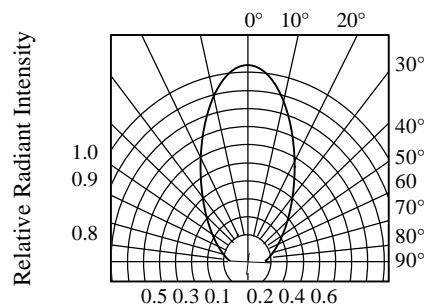


FIG.6 RADIATION DIAGRAM